

Product data sheet

1. Product profile

1.1 General description

The BB207 is a variable capacitance double diode with a common cathode, fabricated in silicon planar technology, and encapsulated in the SOT23 small plastic SMD package.

1.2 Features and benefits

- Excellent linearity
- C_{d(1V)}: 81 pF; C_{d(7.5V)}: 27.6 pF
- C_{d(1V)} to C_{d(7.5V)} ratio: min. 2.6
- Very low series resistance
- Small plastic SMD package.

1.3 Applications

Electronic tuning in FM-radio.

2. Pinning information

Pin	Description	Simplified outline	Symbol
1	anode 1	_	
2	anode 2		3
3	common cathode		

3. Ordering information

Table 2. Ordering information						
Type number	Package	je				
	Name	Description	Version			
BB207	-	plastic surface mounted package; 3 leads	SOT23			



sym032

Marking 4.

Table 3. Markin	
Type number	Marking code ^[1]
BB207	*13

[1] * = p: made in Hong Kong. * = w: made in China.

Limiting values 5.

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per diode					
V _R	continuous reverse voltage		-	15	V
I _F	continuous forward current		-	20	mA
T _{stg}	storage temperature		-55	+150	°C
Tj	junction temperature		-55	+125	°C

Characteristics 6.

Electrical Characteristics Table 5.

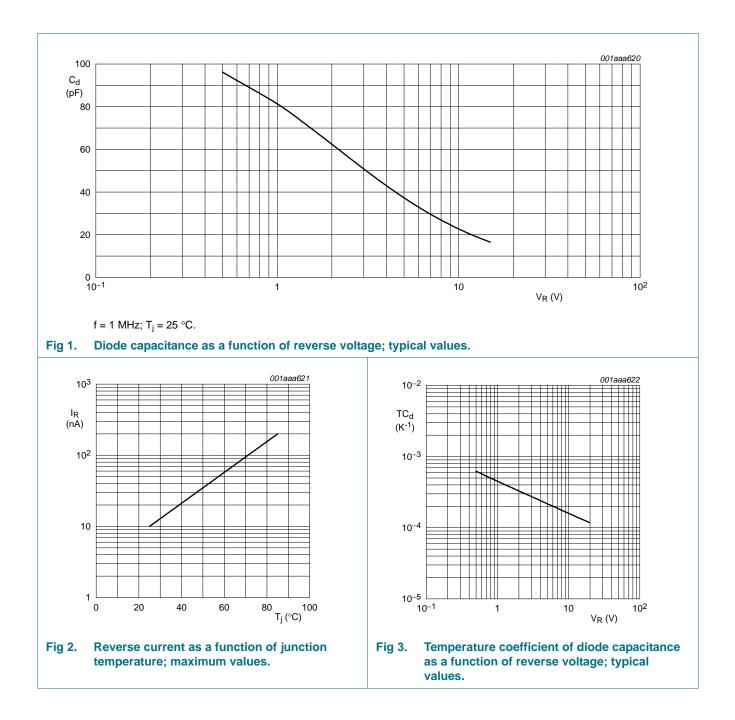
 $T_i = 25 \ ^{\circ}C$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Per diode						
I _R	reverse current	V _R = 15 V; see <u>Figure 2</u>	-	_	10	nA
		V_R = 15 V; T_j = 85 °C; see <u>Figure 2</u>	-	_	200	nA
r _s	diode series resistance	f = 100 MHz; V _R = 3 V	-	0.2	0.4	Ω
C _d	diode capacitance	V _R = 1 V; f = 1 MHz; see <u>Figure 1</u>	76	81	86	pF
		$V_R = 3 V$; f = 1 MHz; see Figure 1	-	50.5	-	pF
		$V_R = 7.5 V$; f = 1 MHz; see Figure 1	25.5	27.6	29.7	pF
		$V_R = 8 V; f = 1 MHz; see Figure 1$	-	26.3	-	pF
$\frac{C_{d(1V)}}{C_{1/7,5V}}$	capacitance ratio	f = 1 MHz	2.6	_	3.3	

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7. Package outline

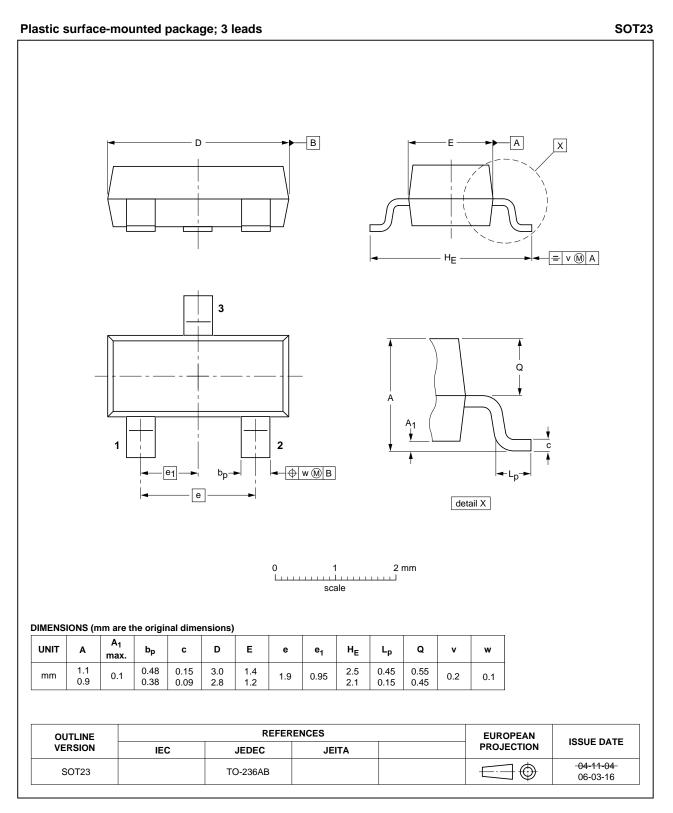


Fig 4. Package outline.

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8. Revision history

Table 6. Revision h	nistory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BB207 v.3	20110907	Product data sheet	-	BB207 v.2
Modifications:		t of this data sheet has bee of NXP Semiconductors.	en redesigned to comply v	vith the new identity
	 Legal texts 	s have been adapted to the	new company name whe	ere appropriate.
	 Package d 	outline drawings have been	updated to the latest vers	sion.
BB207 v.2 (9397 750 13003)	20040427	Product data	-	BB207_N v.1
BB207_N v.1 (9397 750 12695)	20031117	Preliminary data	-	-

9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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